Supertex inc.



P-Channel Enhancement-Mode Vertical DMOS FET

Features

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C_{ISS} and fast switching speeds
- High input impedance and high gain
- Excellent thermal stability
- Integral source-to-drain diode

Applications

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

General Description

The Supertex VP2106 is an enhancement-mode (normallyoff) transistor that utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors, and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

Device	Package Option	$\mathbf{BV}_{DSS}/\mathbf{BV}_{DGS}$	R _{DS(ON)}	D _{D(ON)}	
	TO-92	(V)	(max) (Ω)	(min) (mA)	
VP2106	VP2106N3-G	-60	12	-500	

-G indicates package is RoHS compliant ('Green')

Absolute Maximum Ratings



Parameter

Pin Configuration



BV_{DSS} Product Marking

Value

Drain-to-source voltage	BV _{DSS}		
Drain-to-gate voltage	BV_{DGS}		
Gate-to-source voltage	±20V		
Operating and storage temperature	-55°C to +150°C		
Soldering temperature*	300°C		

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground. SiVP 2 1 0 6 YYWW YY = Year Sealed WW = Week Sealed = "Green"

WW = Week Sealed _____ = "Green" Packaging

Package may or may not include the following marks: Si or 🎲 **TO-92 (N3)**

* Distance of 1.6mm from case for 10 seconds.

Thermal Characteristics

Package	l _D (continuous) [†] (mA)	Ι _D (pulsed) (mA)	Power Dissipation @T _A = 25°C (W)	θ _{jc} (°C/W)	θ _{ja} (°C/W)	l _{DR} ⁺ (mA)	l _{DRM} (mA)
TO-92	-250	-800	0.74	125	170	-250	-800

Notes:

† I_{D} (continuous) is limited by max rated T_{i} .

Electrical Characteristics (*T_A* = 25°C unless otherwise specified)

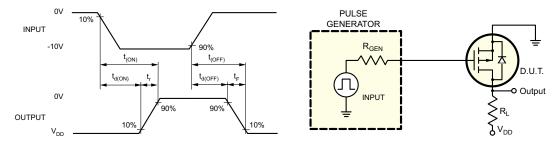
Sym	Parameter	Min	Тур	Max	Units	Conditions	
BV _{DSS}	Drain-to-source breakdown voltage	-60	-	-	V	V _{GS} = 0V, I _D = -1.0mA	
V _{GS(th)}	Gate threshold voltage	-1.5	-	-3.5	V	$V_{GS} = V_{DS}, I_{D} = -1.0 \text{mA}$	
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with temperature	-	5.8	6.5	mV/ºC	$V_{GS} = V_{DS}, I_{D} = -1.0 \text{mA}$	
I _{GSS}	Gate body leakage	-	-1.0	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
I _{DSS}	Zero gate voltage drain current	-	-	-10	μA	V_{GS} = 0V, V_{DS} = Max Rating	
		-	-	-1.0	mA	$V_{_{DS}} = 0.8$ Max Rating, $V_{_{GS}} = 0V$, $T_{_{A}} = 125^{\circ}C$	
I _{D(ON)}	On-state drain current	-0.5	-1.0	-	A	V _{GS} = -10V, V _{DS} = -25V	
R _{DS(ON)}	Static drain-to-source on-state resistance	-	11	15	Ω	V _{GS} = -5.0V, I _D = -100mA	
		-	9.0	12		V _{GS} = -10V, I _D = -500mA	
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with temperature	-	0.55	1.0	%/°C	V _{GS} = -10V, I _D = -500mA	
G _{FS}	Forward transductance	150	200	-	mmho	V _{DS} = -25V, I _D = -500mA	
C _{ISS}	Input capacitance	-	45	60		V _{GS} = 0V, V _{DS} = -25V, f = 1.0MHz	
C _{oss}	Common source output capacitance	-	22	30	pF		
C _{RSS}	Reverse transfer capacitance	-	3.0	8.0			
t _{d(ON)}	Turn-on delay time	-	4.0	5.0		V _{DD} = -25V, I _D = -500mA,	
t _r	Rise time	-	5.0	8.0	ns		
t _{d(OFF)}	Turn-off delay time	-	5.0	9.0	115	$R_{GEN} = 25\Omega$	
t _r	Fall time	-	4.0	8.0		GEN	
V _{SD}	Diode forward voltage drop	-	-1.2	-2.0	V	V _{GS} = 0V, I _{SD} = -500mA	
t _{rr}	Reverse recovery time	-	400	-	ns	V _{GS} = 0V, I _{SD} = -500mA	

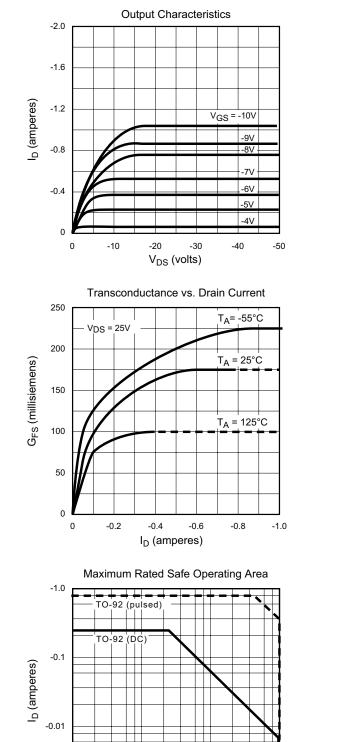
Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)

2. All A.C. parameters sample tested.

Switching Waveforms and Test Circuit





T_A = 25°C

-1.0

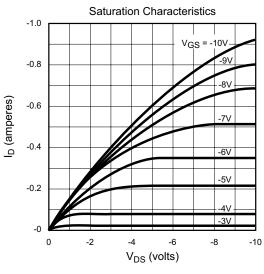
V_{DS} (volts)

-10

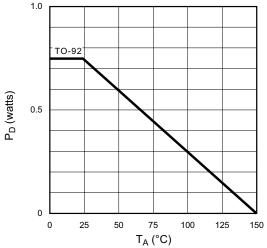
-0.001

-0.1

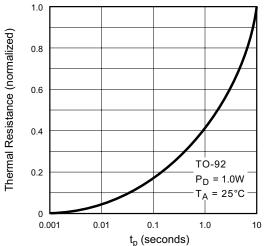
Typical Performance Curves



Power Dissipation vs. Ambient Temperature

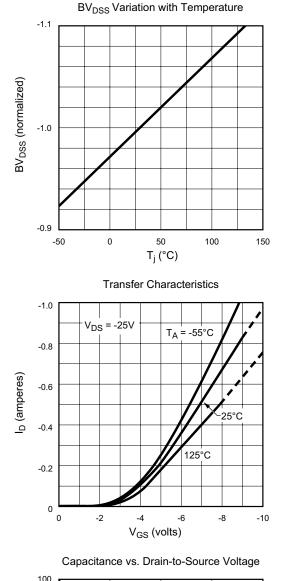


Thermal Response Characteristics

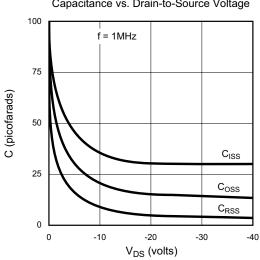


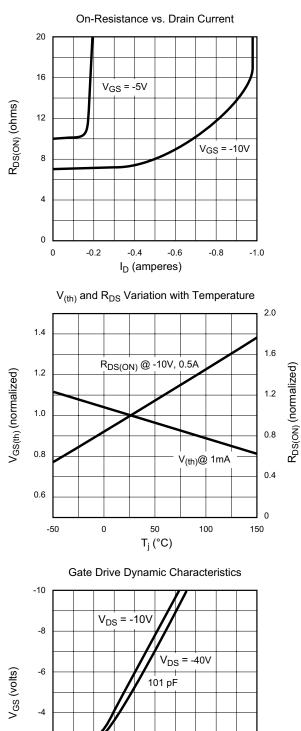
-100

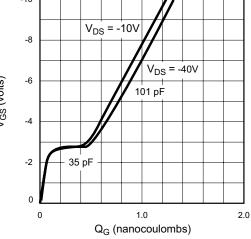
VP2106



Typical Performance Curves (cont.)







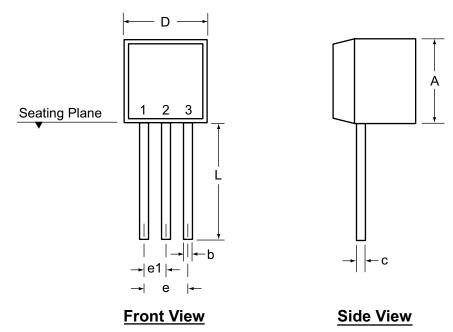
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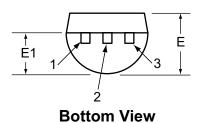
.500

_

.610*

3-Lead TO-92 Package Outline (N3)





Symbol D Ξ Α b E1 e1 С е MIN .170 .014[†] .014[†] .175 .125 .080 .095 .045 Dimensions NOM -_ _ -_ -_ _ (inches)

.022[†]

JEDEC Registration TO-92.

* This dimension is not specified in the original JEDEC drawing. The value listed is for reference only.

.022†

† This dimension is a non-JEDEC dimension.

MAX

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version D080408.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>http://www.supertex.com/packaging.html</u>.)

.205

.165

.105

.105

.055

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